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# Dual N-Channel PowerTrench<sup>®</sup> MOSFET Q1: 30V, 32A, 8.5m $\Omega$ Q2: 30V, 30A, 5.5m $\Omega$

# Features

#### Q1: N-Channel

- Max  $r_{DS(on)}$  = 8.5m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 12A
- Max  $r_{DS(on)}$  = 12.4m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 10A

#### Q2: N-Channel

- Max  $r_{DS(on)}$  = 5.5m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 16A
- Max  $r_{DS(on)}$  = 7.0m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 14A
- Low Qg high side MOSFET
- Low r<sub>DS(on)</sub> low side MOSFET
- Thermally efficient dual Power 56 package
- Pinout optimized for simple PCB design
- RoHS Compliant



# **General Description**

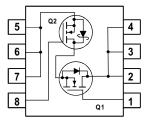
This device includes two specialized MOSFETs in a unique dual Power 56 package. It is designed to provide an optimal Synchronous Buck power stage in terms of efficiency and PCB utilization. The low switching loss "High Side" MOSFET is complemented by a Low Conduction Loss "Low Side" SyncFET.

# Applications

Synchronous Buck Converter for:

- Notebook System Power
- General Purpose Point of Load





# MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol		Paran	neter		Q1	Q2	Units	
V <sub>DS</sub>	Drain to Source	e Voltage			30	30	V	
V <sub>GS</sub>	Gate to Source	Voltage			±20	±20	V	
	Drain Current	-Continuous	T <sub>C</sub> = 25°C		32	30		
I <sub>D</sub>		-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	12	16	А	
_		-Pulsed			60	60		
D	Power Dissipati	on for Single Operation		(Note 1a)	2.	5	w	
P <sub>D</sub>	(Note 1b)					1.0		
T <sub>J</sub> , T <sub>STG</sub>	Operating and \$	Storage Junction Tempe	rature Range		-55 to	+150	°C	

### **Thermal Characteristics**

$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	5	0	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1b)	1:	20	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3	1.2	

# Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS9600S	FDMS9600S	Power 56	13"	12mm	3000 units

May 2014

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	acteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$ $I_D = 1 m A, V_{GS} = 0V$	Q1 Q2	30 30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25°C $I_D = 1$ mA, referenced to 25°C	Q1 Q2		35 29		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V	Q1 Q2			1 500	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±20V, $V_{DS}$ = 0V	Q1 Q2			±100 ±100	nA nA
On Chara	octeristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$ $V_{GS} = V_{DS}, I_D = 1 m A$	Q1 Q2	1 1	1.5 1.8	3 3	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25°C $I_D = 1$ mA, referenced to 25°C	Q1 Q2		-4.5 -6.0		mV/°C
							1

Temperature Coefficient	I <sub>D</sub> = 1mA, referenced to 25°C	Q2		-6.0			1
	V <sub>GS</sub> = 10V, I <sub>D</sub> = 12A			7.0	8.5		1
	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 10A	Q1		9.2	12.4		ĺ
Drain to Source On Resistance	$V_{GS}$ = 10V, $I_D$ = 12A , $T_J$ = 125°C			8.6	13.0	mO	ĺ
	V <sub>GS</sub> = 10V, I <sub>D</sub> = 16A			4.5	5.5	1115.2	ĺ
	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 14A	Q2		5.3	7.0		ĺ
	$V_{GS}$ = 10V, $I_D$ = 16A , $T_J$ = 125°C			5.4	8.3		ĺ
Forward Transconductance	V <sub>DD</sub> = 10V, I <sub>D</sub> = 12A	Q1		54		c	ĺ
	V <sub>DD</sub> = 10V, I <sub>D</sub> = 16A	Q2		68		3	
		$ \begin{array}{c} U_{GS} = 10V, \ I_{D} = 12A \\ V_{GS} = 4.5V, \ I_{D} = 10A \\ V_{GS} = 4.5V, \ I_{D} = 10A \\ V_{GS} = 10V, \ I_{D} = 12A, \ T_{J} = 125^{\circ}C \\ \hline V_{GS} = 10V, \ I_{D} = 16A \\ V_{GS} = 4.5V, \ I_{D} = 14A \\ V_{GS} = 10V, \ I_{D} = 16A, \ T_{J} = 125^{\circ}C \\ \hline \end{array} $	$ \begin{array}{ c c c c c c } \hline & & & & & & & & & & & & & & & & & & $	$ \begin{array}{c c} & & & \\ \hline \\ Drain to Source On Resistance \\ \hline \\ \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$ \begin{array}{ c c c c c c c } \hline & & & & & & & & & & & & & & & & & & $

# **Dynamic Characteristics**

			<b>A</b> (	1000	1 = 0 =	i
C <sub>iss</sub>	Input Capacitance		Q1	1280	1705	pF
Ciss	input Capacitance		Q2	2300	3060	рі
C	Output Canaditanaa		Q1	525	700	ъĘ
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f= 1MHz	Q2	1545	2055	pF
<u>_</u>	Deverse Transfer Conseitence		Q1	80	120	~ <b>F</b>
C <sub>rss</sub>	Reverse Transfer Capacitance		Q2	250	375	pF
D	Gate Resistance	f = 1MHz	Q1	1.0		Ω
R <sub>g</sub>	Gale Resistance		Q2	1.7		52

# **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		Q1 Q2	13 17	23 31	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 10V, I <sub>D</sub> = 1A,	Q1 Q2	6 11	12 20	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$	Q1 Q2	42 54	67 86	ns
t <sub>f</sub>	Fall Time		Q1 Q2	12 32	22 51	ns
Q <sub>g(TOT)</sub>	Total Gate Charge	Q1 V <sub>DD</sub> = 15V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 12A	Q1 Q2	9 21	13 29	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	Q2	Q1 Q2	3 8		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	V <sub>DD</sub> = 15V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 16A	Q1 Q2	2.7 6.5		nC

Symbol	Parameter	Test Conditions		Туре	Min	Тур	Max	Units
Drain-Soເ	Irce Diode Characteristics							
I <sub>S</sub>	Maximum Continuous Drain-Source Dio	de Forward Current		Q1 Q2			2.1 3.5	А
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 3.5A$	(Note 2) (Note 2) (Note 2)	Q1 Q2 Q2		0.7 0.4 0.5	1.2 1.0 1.0	v
t <sub>rr</sub>	Reverse Recovery Time	Q1 I <sub>F</sub> = 12A, di/dt = 100A/μs		Q1 Q2		33 27		ns
Q <sub>rr</sub>	Reverse Recovery Charge	Q2 I <sub>F</sub> = 16A, di/dt = 300A/µs		Q1 Q2		20 33		nC

Notes:
R<sub>0JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



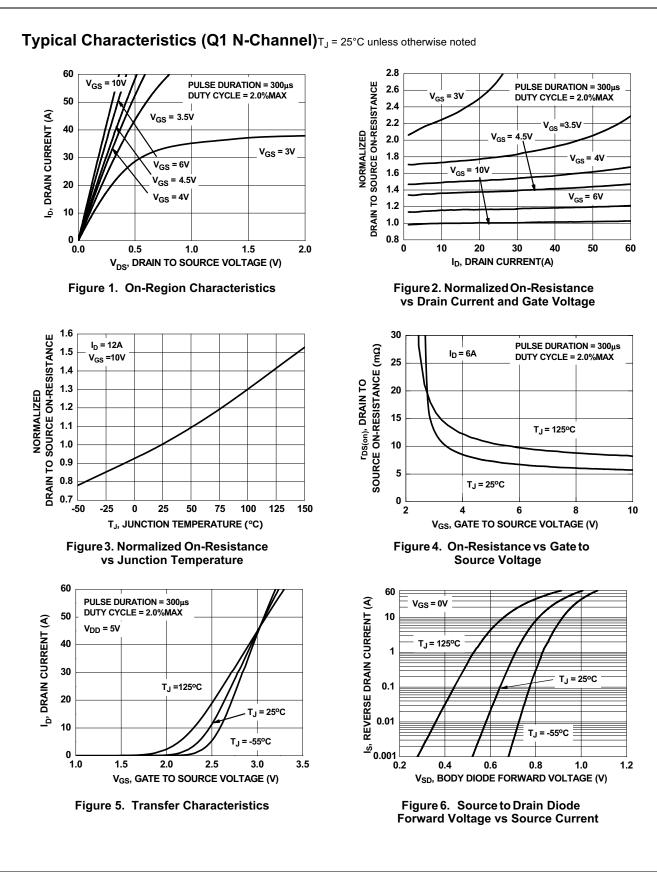
2: Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0%.

a.50°C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



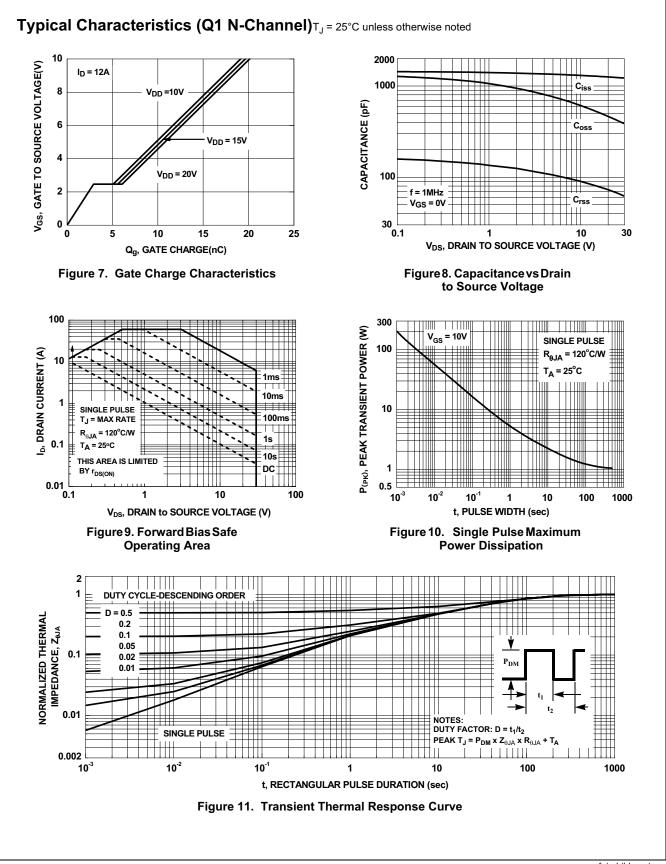
b. 120°C/W when mounted on a minimum pad of 2 oz copper





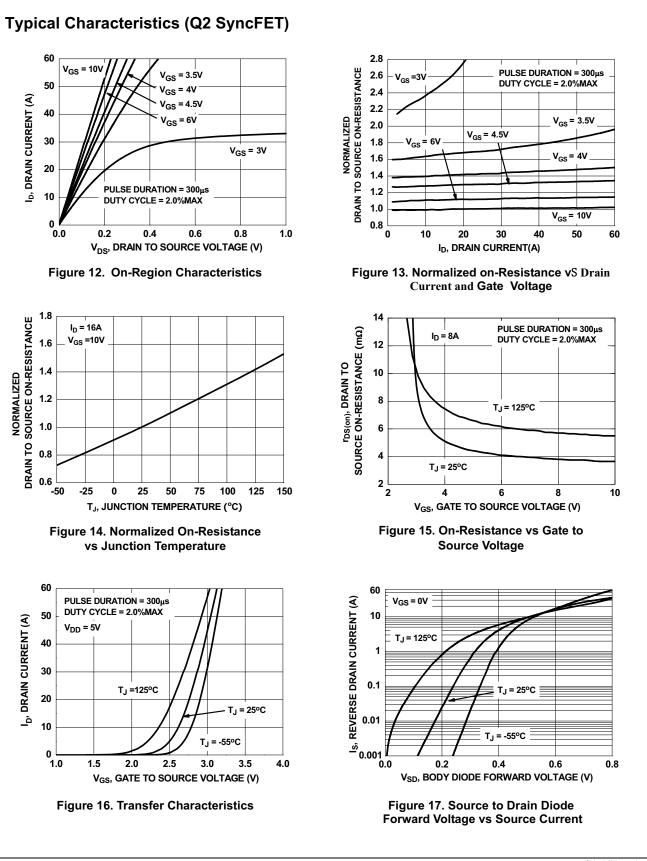
FDMS9600S Rev.D2

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FDMS9600S Dual N-Channel PowerTrench<sup>®</sup> MOSFET

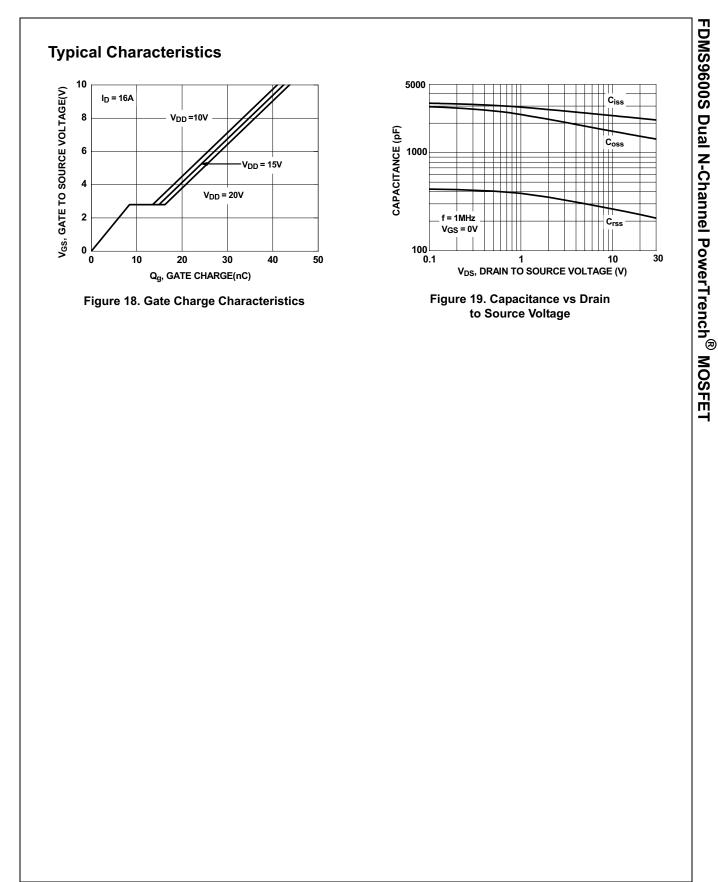


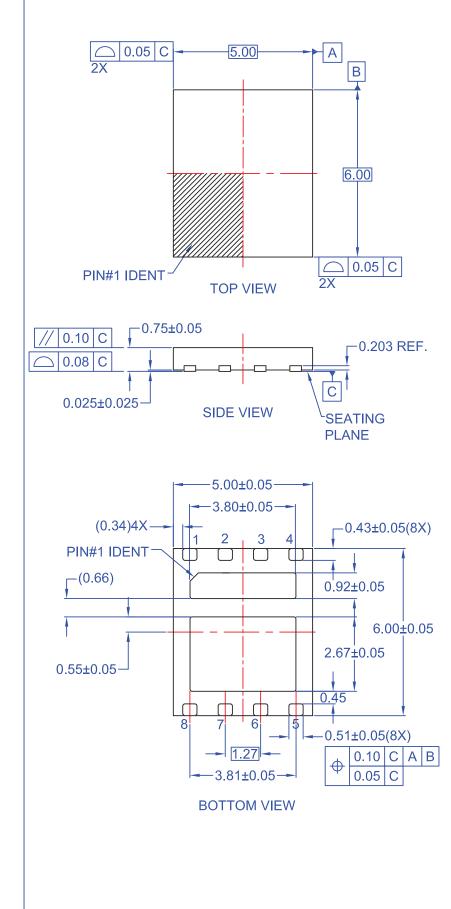
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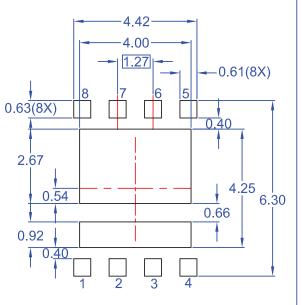
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#### RECOMMENDED LAND PATTERN

NOTE:

- A. PACKAGE DOES NOT FULLY CONFORM TO JEDEC STANDARD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP08Krev3.



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